Special Issue

Advances in Micro-Milling, 2nd Edition

Message from the Guest Editors

With the increasing demand for micro-structures/parts in aerospace, biomedical, microelectronics and other industries, micro-milling technology, which uses a highfrequency spindle together with cutting tools with diameters smaller than 1 mm, has become common because of its machining accuracy and machining capabilities. This Special Issue is devoted to advances in the scientific understanding of micro-milling, mainly in metals, but also in composites, ceramics and other structural/functional materials. We welcome research papers, short communications, and review articles that focus on the research, design, manufacture, performance validation, and application of highprecision machining, including fundamental and applied research and development in micro-milling processes and advanced measurement science. The scope includes micro-milling systems and supporting metrology at the microscale.

Guest Editors

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Deadline for manuscript submissions

closed (30 March 2024)



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